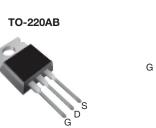


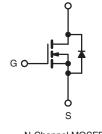
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	1000				
R _{DS(on)} (Ω)	V _{GS} = 10 V 5.0				
Q _g (Max.) (nC)	80				
Q _{gs} (nC)	10				
Q _{gd} (nC)	42				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBG30PbF			
	SiHFBG30-E3			
SnPb	IRFBG30			
	SiHFBG30			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	1000	v	
Gate-Source Voltage			V _{GS}	± 20		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C		3.1		
	V _{GS} at 10 V	T _C = 100 °C	I _D	2.0	А	
Pulsed Drain Current ^a			I _{DM}	12		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	280	mJ	
Repetitive Avalanche Current ^a			I _{AR}	3.1	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	125	W	
Peak Diode Recovery dV/dtc			dV/dt	1.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 55 mH, R_g = 25 Ω , I_{AS} = 3.1 A (see fig. 12).

c. $I_{SD} \le 3.1$ A, dl/dt ≤ 80 A/µs, $V_{DD} \le 600$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91124 S11-0517-Rev. B, 21-Mar-11

www.vishay.com

1



Vishay Siliconix



THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	0.50 -		°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.0						
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0	0 V, I _D = 2	250 μA	1000	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C,	$I_D = 1 \text{ mA}$	-	1.4	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	/ _{GS} , I _D = 2	250 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	Vo	_{GS} = ± 20	V	-	-	± 100	nA
Zero Gate Voltage Drain Current	lass	$V_{DS} = 1000 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	100	ıιΔ	
	I _{DSS}	V _{DS} = 800 V,	V_{DS} = 800 V, V_{GS} = 0 V, T_{J} = 125 °C		-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 1.9 \text{ A}^{b}$		-	-	5.0	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.9 \text{ A}^{b}$		2.1	-	-	S	
Dynamic	_							-
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	980	-	pF	
Output Capacitance	C _{oss}	$V_{DS} = 25 V,$		-	140	-		
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	50	-		
Total Gate Charge	Qg	V _{GS} = 10 V			-	-	80	nC
Gate-Source Charge	Q _{gs}				-	-	10	
Gate-Drain Charge	Q _{gd}	-	see fig. 6 and 13 ^b		-	-	42	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 500 V, I_D = 3.1 A R_g = 12 Ω,R_D = 170 Ω,see fig. 10^b		-	12	-	ns	
Rise Time	t _r			-	25	-		
Turn-Off Delay Time	t _{d(off)}			-	89	-		
Fall Time	t _f			-	29	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs					•		•
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.1	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	12		
Body Diode Voltage	V_{SD}	T _J = 25 °C,	l _S = 3.1 A	, $V_{GS} = 0 V^{b}$	-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 3.1 \text{ A}, dl/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	410	620	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.3	2.0	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn	-on time	is negligible (turn	i-on is dor	minated b	y L _S and	L _D)

Notes

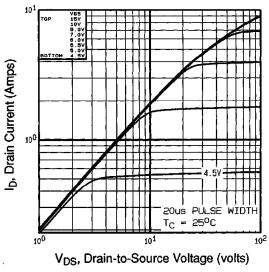
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

www.vishay.com 2 Document Number: 91124 S11-0517-Rev. B, 21-Mar-11



Vishay Siliconix



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



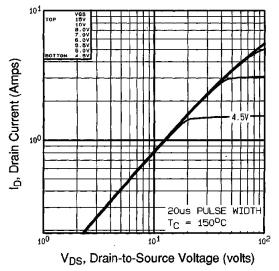


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

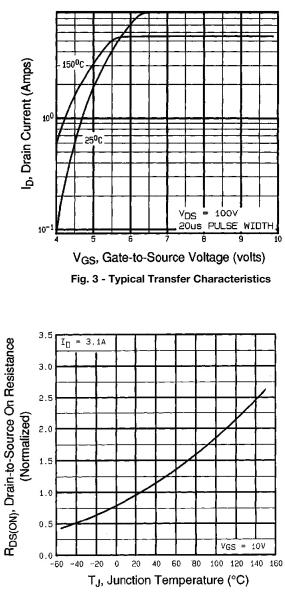


Fig. 4 - Normalized On-Resistance vs. Temperature

Vishay Siliconix



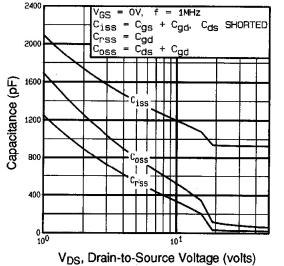
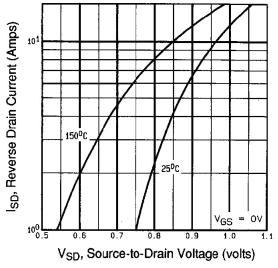
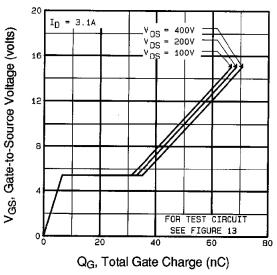


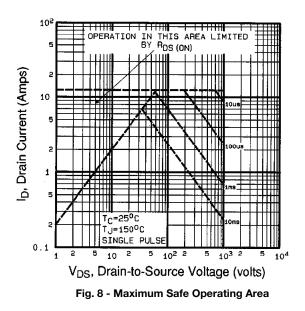
Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage











Document Number: 91124 S11-0517-Rev. B, 21-Mar-11

This datasheet is subject to shance without patice.
THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEE Downloaded From Oneyac.com // MERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix

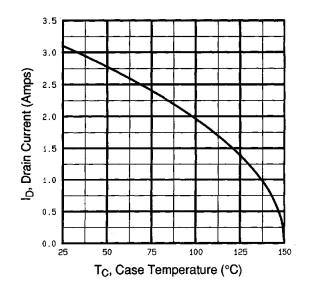


Fig. 9 - Maximum Drain Current vs. Case Temperature

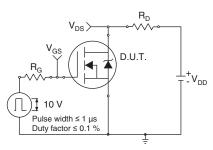


Fig. 10a - Switching Time Test Circuit

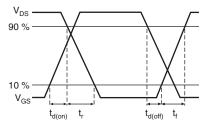


Fig. 10b - Switching Time Waveforms

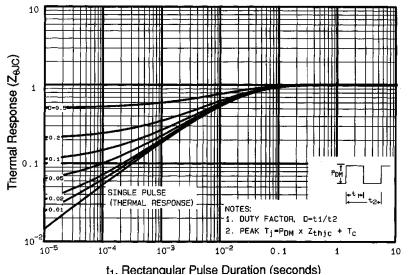


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

This detection of the change without active.

THE PRODUCT DESCRIBED HEREIN AND THIS DATASH Downloaded From Oneyac.com

AIMERS, SET FORTH AT www.vishay.com/doc?91000

Vishay Siliconix



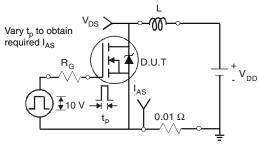


Fig. 12a - Unclamped Inductive Test Circuit

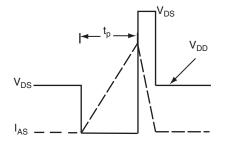


Fig. 12b - Unclamped Inductive Waveforms

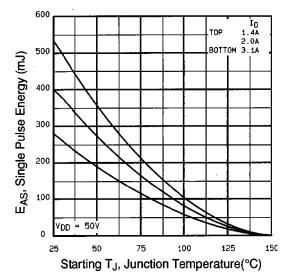


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

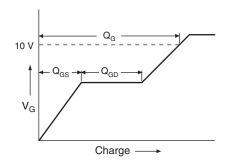
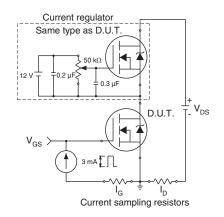
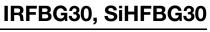


Fig. 13a - Basic Gate Charge Waveform



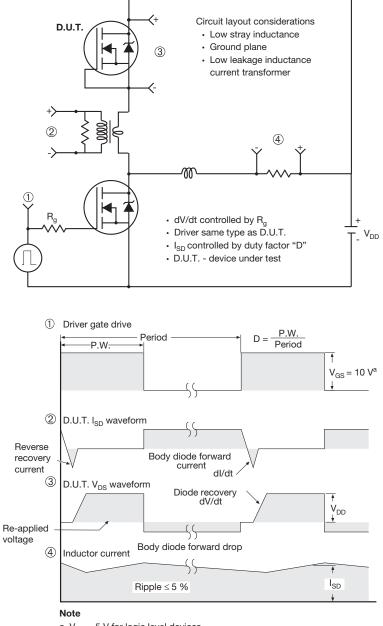




Vishay Siliconix



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

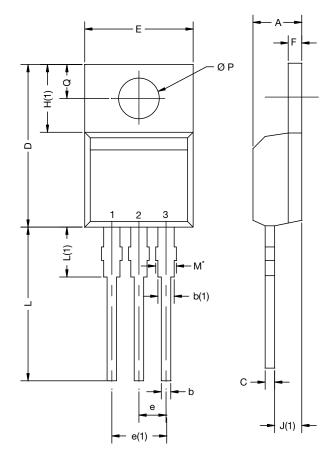
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?91124.

Document Number: 91124 S11-0517-Rev. B, 21-Mar-11



VISHAY www.vishay.com

TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

Document Number: 66542

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From Oneyac.com



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)